

AOT260L-VB Datasheet N-Channel 60 V (D-S) MOSFET

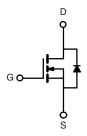
PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}$ (Ω) at $V_{GS} = 10 \text{ V}$	0.0016			
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0020			
I _D (A)	270			
Configuration	Single			

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- \bullet 100 % $R_{\rm g}$ and UIS tested







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V_{DS}	60	V		
Gate-Source Voltage		V_{GS}	± 20	V		
Continuous Drain Current	T _C = 25 °C	- I _D	270			
Continuous Drain Current	T _C = 125 °C		120 ^a			
Continuous Source Current (Diode Conduction)	I _S	120 ^a	Α			
Pulsed Drain Current ^b	I _{DM}	600				
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	75			
Single Pulse Avalanche Energy	L=0.1111H	E _{AS}	281	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	375	W		
	T _C = 125 °C		125	VV		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)		R_{thJC}	0.4	G/ VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).



PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	1			l				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	_	V	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.5	2.0	2.5	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 125 °C	-	-	50	PA	
		$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 175 °C	-	-	1.5	mA	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	120	-	-	Α	
		V _{GS} = 10 V	I _D = 30 A	-	0.0016	-	Ω	
Drain-Source On-State Resistance a	D	V _{GS} = 10 V	I _D = 30 A, T _J = 125 °C	-	0.0031	-		
Diani-Source On-State nesistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	0.0037	-		
		$V_{GS} = 4.5 \text{ V}$	I _D = 20 A	-	0.0020	-]	
Forward Transconductance b	9fs	V _{DS} = 15 V, I _D = 30 A		-	164	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	12 060	15 100	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	5750	7200		
Reverse Transfer Capacitance	C _{rss}			-	860	1100		
Total Gate Charge ^c	Q_g			-	128	200		
Gate-Source Charge ^c	Q_{gs}	V _{GS} = 10 V	$V_{DS} = 30 \text{ V}, I_{D} = 80 \text{ A}$	-	33	-	nC	
Gate-Drain Charge ^c	Q_{gd}			-	11	-		
Gate Resistance	R_g	f = 1 MHz		0.8	1.68	2.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD}=30$ V, $R_L=0.375$ Ω $I_D\cong 80$ A, $V_{GEN}=10$ V, $R_g=1$ Ω		-	20	25		
Rise Time ^c	t _r			-	15	40	- ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	65	100		
Fall Time ^c	t _f			-	12	20		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	300	Α	
Forward Voltage	V_{SD}	I _F = 80 A, V _{GS} = 0 V		-	0.88	1.5	V	

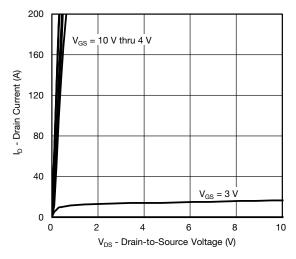
Notes

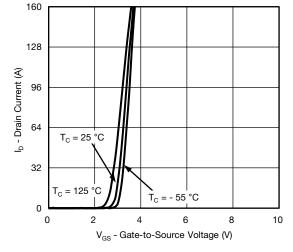
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

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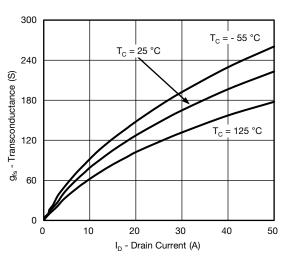
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

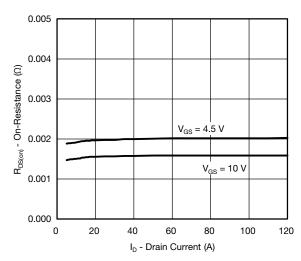




Output Characteristics

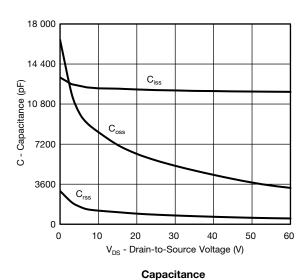
Transfer Characteristics

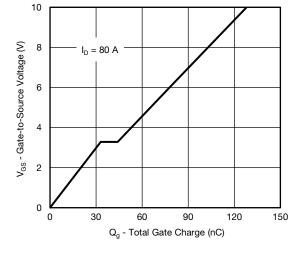




Transconductance

On-Resistance vs. Drain Current



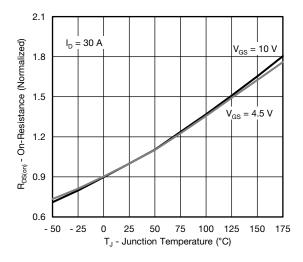


Gate Charge

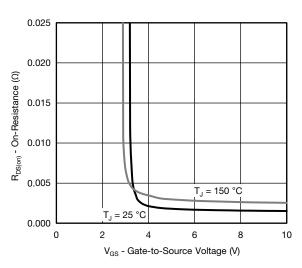
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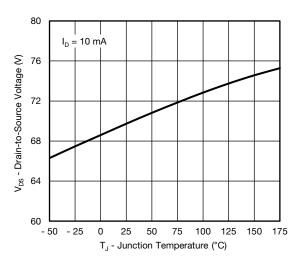
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



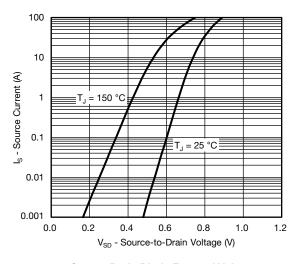
On-Resistance vs. Junction Temperature



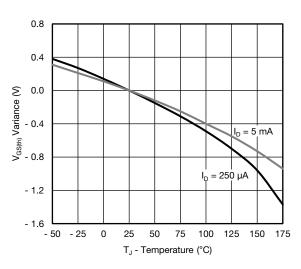
On-Resistance vs. Gate-to-Source Voltage



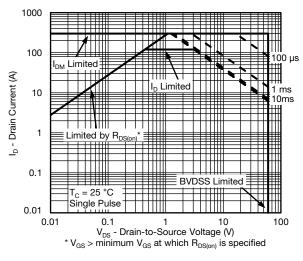
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



Threshold Voltage

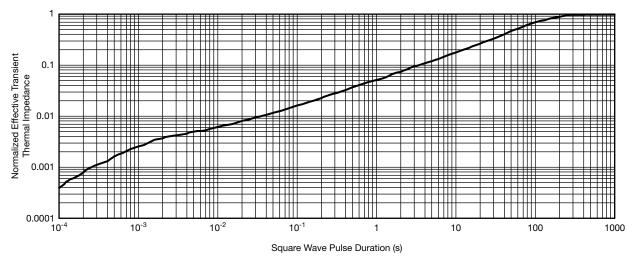


Safe Operating Area

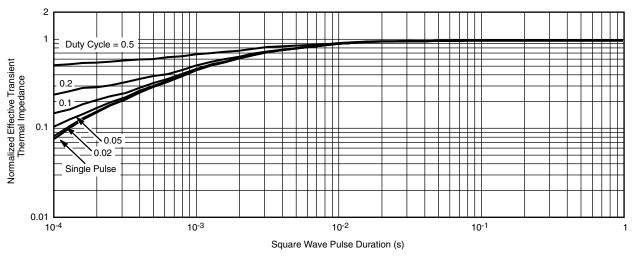
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



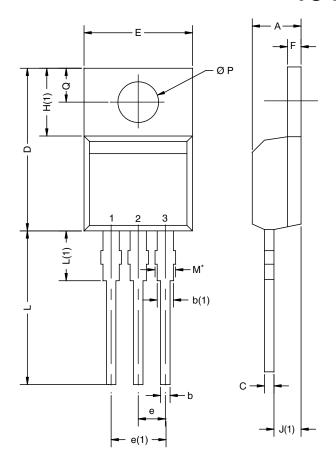
Normalized Thermal Transient Impedance, Junction-to-Case

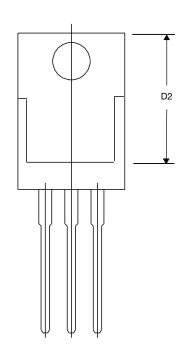
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-220AB





		INC	HES	MILLIN	METERS			
DIM.		MIN.	MAX.	MIN.	MAX.			
Α		0.160	0.190	4.064	4.826			
	b	0.020	0.039	0.508	0.990			
	b1	0.020	0.035	0.508	0.889			
	b2	0.045	0.055	1.143	1.397			
C*	Thin lead	0.013	0.018	0.330	0.457			
	Thick lead	0.023	0.028	0.584	0.711			
c1	Thin lead	0.013	0.017	0.330	0.431			
CI	Thick lead	0.023	0.027	0.584	0.685			
	c2	0.045	0.055	1.143	1.397			
	D	0.340	0.380	8.636	9.652			
	D1 0.220		0.240	5.588	6.096			
	D2	0.038	0.042	0.965	1.067			
	D3	0.045	0.055	1.143	1.397			
	D4	0.044	0.052	1.118	1.321			
	E	0.380	0.410	9.652	10.414			
E1		0.245	-	6.223	-			
E2		0.355	0.375	9.017	9.525			
E3		0.072	0.078	1.829	1.981			
<u>е</u>		0.100 BSC		2.54 BSC				
K		0.045	0.055	1.143	1.397			
L		0.575	0.625	14.605	15.875			
L1		0.090	0.110	2.286	2.794			
L2		0.040	0.055	1.016	1.397			
L3		0.050	0.070	1.270	1.778			
L4		0.010 BSC		0.254 BSC				
М		-	0.002	-	0.050			
1								

ECN: T13-0707-Rev. K, 30-Sep-13

DWG: 5843

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

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